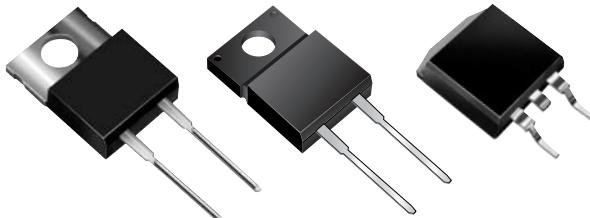
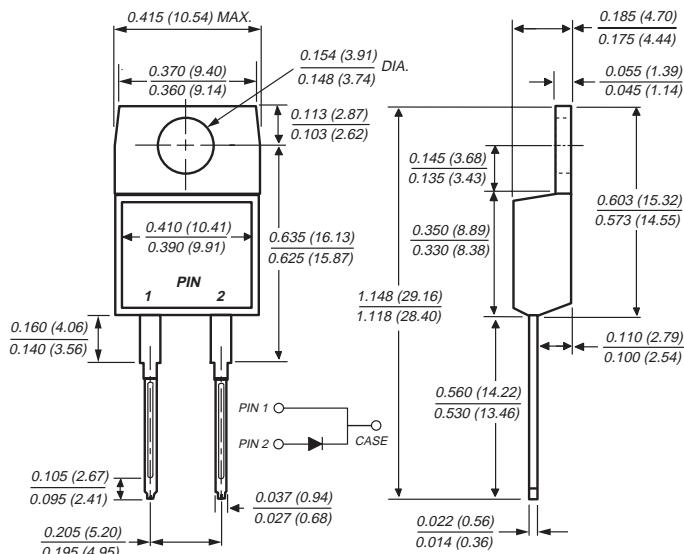
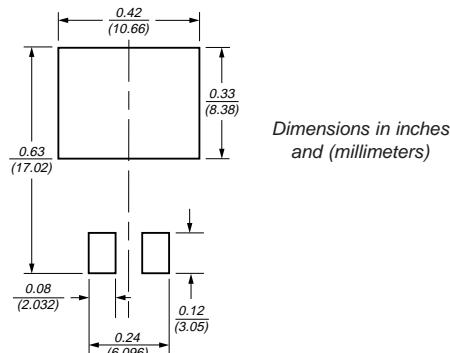


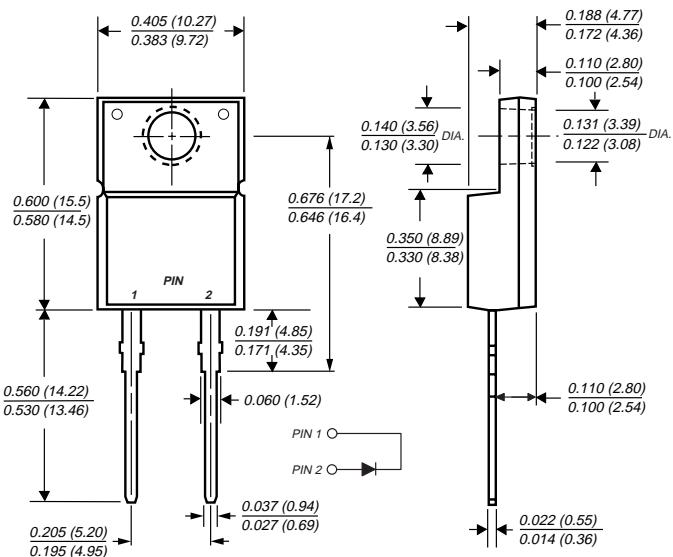
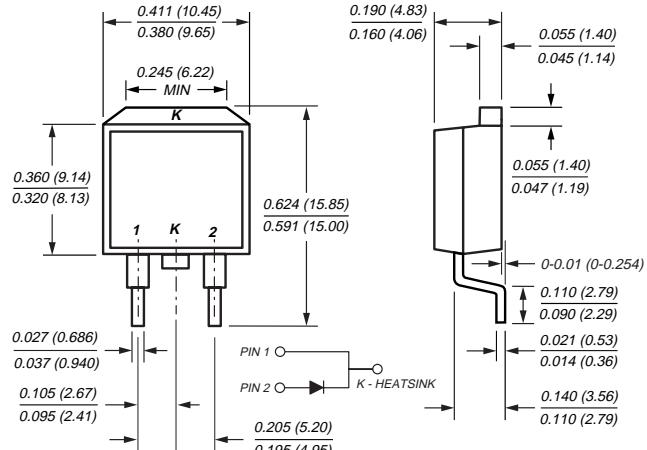
High Voltage Damper Diodes


TO-220AC (BYS459)

Mounting Pad Layout TO-263AB


Features

- Plastic package has Underwriters Laboratories Flammability Classification 94V-0
- Ideally suited CRT horizontal deflection
- Fast reverse recovery time
- Fast forward recovery time
- High temperature soldering in accordance with CECC 802 / Reflow guaranteed
- Glass passivated chip junction

Reverse Voltage 1500V
 Forward Current 10A
 Reverse Recovery Time 350ns

ITO-220AC (BYS459F)

TO-263AB (BYS459B)


Mechanical Data

Case: JEDEC TO-220AC, ITO-220AC & TO-263AB molded plastic body

Terminals: Plated leads, solderable per MIL-STD-750, Method 2026

Polarity: As marked

Mounting Position: Any

Mounting Torque: 10 in-lbs maximum

Weight: 0.08 oz., 2.24 g

Maximum Ratings

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	1500	V
Maximum working reverse voltage	V_{RWM}	1300	V
Maximum DC blocking voltage	V_{DC}	1500	V
Maximum average forward rectified current	$I_{F(AV)}$	10	A
Peak working forward current at $f = 48\text{kHz}$	$I_F(\text{Peak})$	12	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) at $T_J = 150^\circ\text{C}$	I_{FSM}	130	A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$
RMS Isolation voltage (BYS459F types only) from terminals to heatsink with $t = 1.0$ second, $\text{RH} \leq 30\%$	V_{ISOL}	4500 ⁽¹⁾ 3500 ⁽²⁾ 1500 ⁽³⁾	V

Electrical Characteristics

($T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Maximum instantaneous forward voltage ⁽⁴⁾ $I_F = 6.5\text{A}, T_J = 25^\circ\text{C}$ $I_F = 6.5\text{A}, T_J = 125^\circ\text{C}$	V_F	1.3 1.2	V
Maximum DC reverse current at V_{RWM} $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$	I_R	250 1.0	μA mA
Maximum reverse recovery time at $I_F = 1.0\text{A}, dI/dt = 50\text{A}/\mu\text{s}, V_R = 30\text{V}$	t_{rr}	350	ns
Maximum reverse recovery charge at $I_F = 2.0\text{A}, -dI/dt = 20\text{A}/\mu\text{s}$	Q_{rr}	3.0	μC
Maximum forward recovery time $I_F = 6.5\text{A}, dI/dt = 52\text{A}/\mu\text{s}$	t_{fr}	250	ns
Peak forward recovery overshoot voltage $I_F = 6.5\text{A}, dI/dt = 52\text{A}/\mu\text{s}$	V_{FP}	20	V

Thermal Characteristics

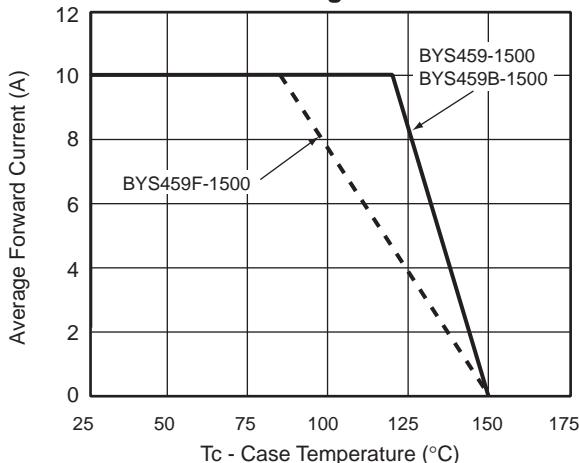
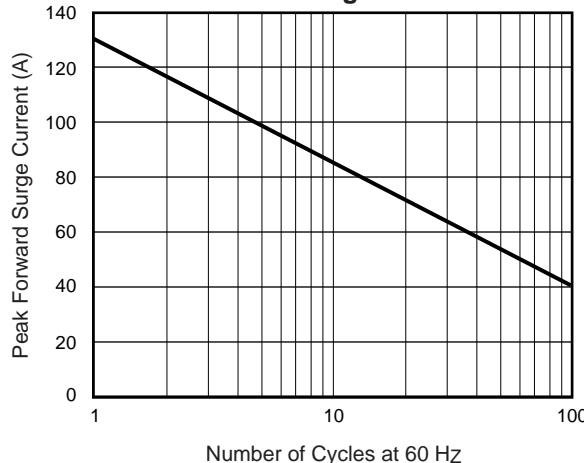
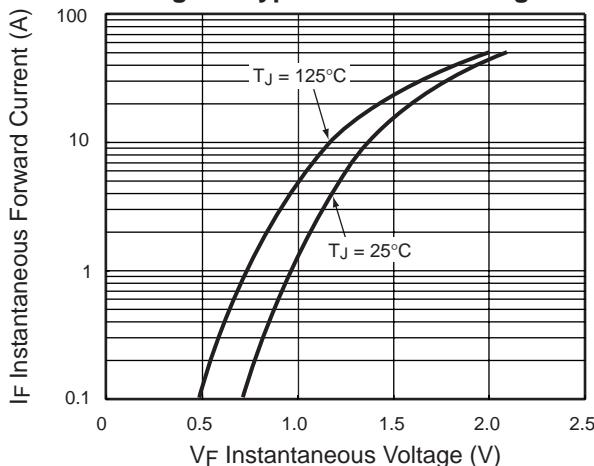
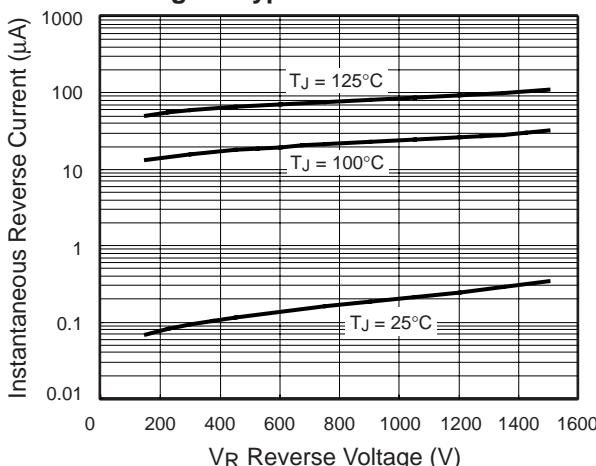
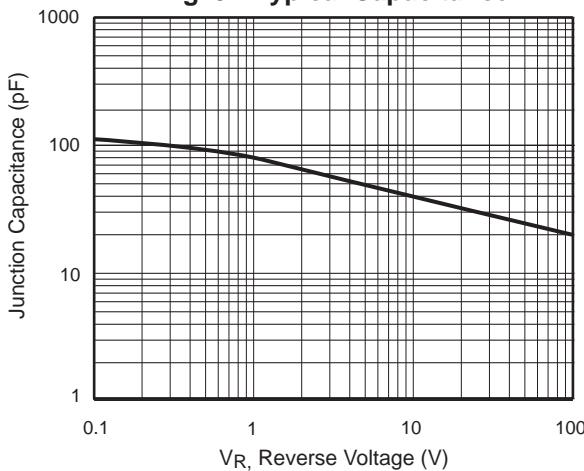
($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	BYS459	BYS459F	BYS459B	Unit
Typical thermal resistance from junction to ambient	$R_{\theta JA}$	60	55	60	$^\circ\text{C/W}$

Notes:

- (1) Clip mounting (on case), where lead does not overlap heatsink with 0.110" offset
- (2) Clip mounting (on case), where leads do overlap heatsink
- (3) Screw mounting with 4-40 screw, where washer diameter is ≤ 4.9 mm (0.19")
- (4) Pulse test: 300 μs pulse width, 1% duty cycle

Ratings and Characteristic Curves ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig. 1 – Forward Current Derating Curve

Fig. 2 – Maximum Non-Repetitive Peak Forward Surge Current

Fig. 3 – Typical Forward Voltage

Fig. 4 – Typical Reverse Current

Fig. 5 – Typical Capacitance

Fig. 6 – Typical Reverse Recovery Time
